**STRIPLINE SURFACE MOUNT** ower Splitter/Combiner 200W

☐ Mini-Circuits

#### 50Ω 2000 to 6000 MHz 2-Way 90°

### **KEY FEATURES**

- High power handling, up to 200W
- Ultra wide bandwidth
- Excellent phase unbalance, ±1.5 deg

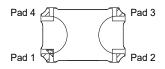
### **APPLICATIONS**

- Balanced amplifiers
- I&Q modulators
- Defense and military

OCH-63+

Generic photo used for illustration purposes only

### **FUNCTIONAL DIAGRAM**



#### **PRODUCT OVERVIEW**

Mini-Circuits' QCH-63+ is a 2-way 90° power splitter, capable of handling up to 200W with amplitude unbalance of ±1.4 dB typ and phase unbalance of ±1.5 deg. typ. Operating over a frequency range of 2000 to 6000 MHz, the outstanding phase and amplitude unbalance make this component a versatile building block for use in a variety of systems and sub-system designs from balanced amplifiers and antenna feeds to military applications and more. The splitter is fabricated using laminated PCB process (0.56 x 0.35 x 0.093") and includes wrap-around terminations for good solderability and easy visual inspection.

#### ELECTRICAL SPECIFICATIONS 1, 2 AT +25°C

Parameter	Conditions (MHz)	Min.	Тур.	Max.	Unit
Frequency Range	-	2000	-	6000	MHz
Mainline Loss <sup>3</sup>	2000 - 6000	-	0.20	0.40	dB
Isolation	2000 - 6000	18	26	-	dB
Phase Unbalance	2000 - 6000	-	±1.50	±7.50	deg
Amplitude Unbalance	2000 - 6000	-	±1.40	±1.50	dB
Return Loss	2000 - 6000	17.5	23	_	dB
Thermal Resistance <sup>4</sup>	2000 - 6000	-	0.35	-	°C/W

1 Tested in Evaluation Board TB-906+ De-embbeded to the device reference plane

2. Model is symmetrical and all ports are interchangeable, see Port Function Description/Configuration table for details and S-Parameters for actual performance.

3. Does not include theoretical loss due to coupling. Nominal theoretical loss is 3 dB.

4. Thermal Resistance is defined as  $\Theta$  ic= (Hot Spot Temperature on DUT - Base Plate Temperature)/Input Power.

### **ABSOLUTE MAXIMUM RATINGS 5**

Operating Case Temperature <sup>6</sup>		-55°C to +105°C	
Storage Temperature		-55°C to +105°C	
	+85°C case	200 W	
Power Input	+95°C case	150 W	
	+105°C case	120 W	

5. Permanent damage may occur if any of these limits are exceeded.

6. Case temperature is defined as temperature on base plate.

## **STRIPLINE SURFACE MOUNT** Power Splitter/Combiner 50Ω

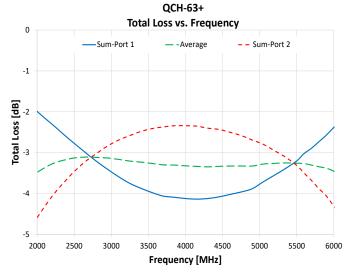
### QCH-63+

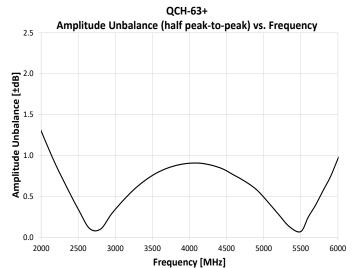
Mini-Circuits

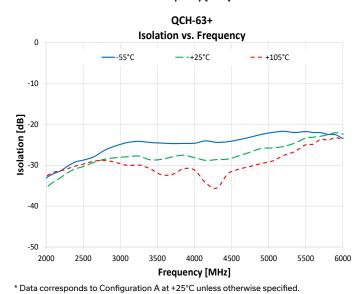
2000 to 6000 MHz

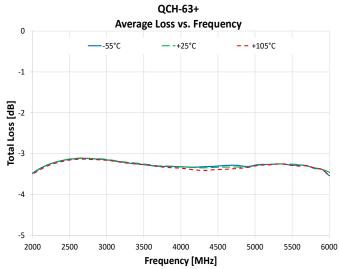
2-Way 90° 200W



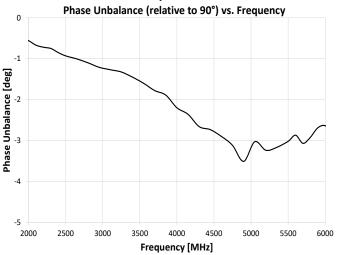




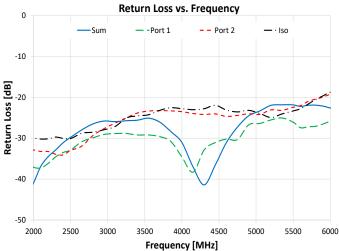




QCH-63+







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## **STRIPLINE SURFACE MOUNT** ower Splitter/Combiner 50Ω

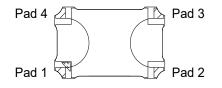
# **OCH-63+**

☐ Mini-Circuits

2000 to 6000 MHz

2-Way 90° 200W

### **FUNCTIONAL DIAGRAM**

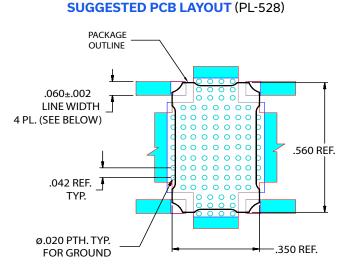


### PAD DESCRIPTION/CONFIGURATION 7

Function	Pad	Description
Sum	1	Sum port
Isolation	2	Isolation port
Port 2 (90°)	3	90° port
Port 1 (0°)	4	0° port
Ground	5	Ground

Configuration	Sum	Isolation	Port 1 (0°)	Port 2 (90°)
A	1	2	4	3
В	2	1	3	4
С	3	4	2	1
D	4	3	1	2

7. Model is symmetrical and all ports are interchangeable, see Port Function Configurations table and s-parameters for actual performance.

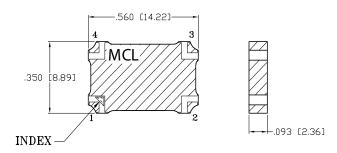


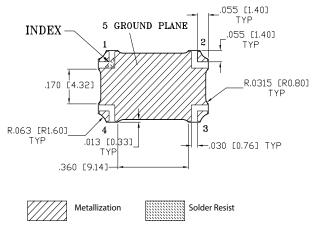
NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RT/DUROID5880 WITH DIELECTRIC THICKNESS 0.02"±.0015". COPPER: 1 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED. 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE. DETINISTED FOR CORPER LAYOUT WITH SMOBC (SOLDER MASK

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDERMASK

### **CASE STYLE DRAWING** (PQ2186)





NOTES

- 1. Base material: Printed wiring laminate.
- 2. Termination finish: 2-5 µinch (.05-.13 microns) Immersion Gold.
- 3. Weight: 1.4 grams
- 4. Marking may contain other features or characters for internal lot control.

#### PRODUCT MARKING\*: QCH-63+

\* Marking may contain other features or characters for internal lot control.

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# **STRIPLINE SURFACE MOUNT** Power Splitter/Combiner



Mini-Circuits

50Ω 2000 to 6000 MHz 2-Way 90°

200W

### ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASH BOARD

CLICK HERE

Performance Data & Graphs	Data Graphs S-Parameter (S4P files) data set (.zip file) de-embedded to device pads	
Case Style	PQ2186 Lead finish: 2-5 inch (0.05-0.13 microns) immersion gold	
RoHS Status	Compliant	
Tape and Reel	F118	
Suggested Layout for PCB Design	PL-528	
Evaluation Board	TB-906+ Gerber file	
Environmental Rating	ENV02T8	

NOTES:

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.

C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at <a href="https://www.minicircuits.com/">https://www.minicircuits.com/</a> terms/viewterm.html

